

Vishay General Semiconductor

# Surface-Mount TMBS® (Trench MOS Barrier Schottky) Rectifier



Cathode O Anode

## **DESIGN SUPPORT TOOLS AVAILABLE**



PRIMARY CHARACTERISTICS			
I <sub>F(AV)</sub>	3.0 A		
V <sub>RRM</sub>	60 V		
I <sub>FSM</sub>	80 A		
$V_F$ at $I_F$ = 3.0 A	0.44 V		
T <sub>J</sub> max.	150 °C		
Package	SMP (DO-220AA)		
Circuit configuration	Single		

### FEATURES

- Low profile package
- Trench MOS Schottky technology
- Low power losses, high efficiency
- Low forward voltage drop
- Meets MSL level 1, per J-STD-020, LF maximum peak of 260 °C
- AEC-Q101 qualified available - Automotive ordering code; base P/NHM3
- Material categorization: for definitions of compliance please see <u>www.vishay.com/doc?99912</u>

### **TYPICAL APPLICATIONS**

For use in low voltage, high frequency inverters, freewheeling, DC/DC converters, and polarity protection applications.

### **MECHANICAL DATA**

Case: SMP (DO-220AA)

Molding compound meets UL 94 V-0 flammability rating

Base P/N-M3 - halogen-free, RoHS-compliant, and commercial grade

Base P/NHM3 - halogen-free, RoHS-compliant, and AEC-Q101 qualified

**Terminals:** matte tin plated leads, solderable per J-STD-002 and JESD 22-B102

M3 suffix meets JESD 201 class 2 whisker test, HM3 suffix meets JESD 201 class 2 whisker test

Polarity: color band denotes the cathode end

<b>MAXIMUM RATINGS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)			
PARAMETER	SYMBOL	V3P6L	UNIT
Device marking code		36L	
Maximum repetitive peak reverse voltage	V <sub>RRM</sub>	60	V
Maximum DC forward current	I <sub>F(AV)</sub> <sup>(1)</sup>	3	А
	I <sub>F(AV)</sub> <sup>(2)</sup>	2.3	А
Peak forward surge current 10 ms single half sine-wave superimposed on rated load	I <sub>FSM</sub>	80	А
Operating junction and storage temperature range	T <sub>J</sub> <sup>(3)</sup>	-40 to +150	°C
Operating junction and storage temperature range	T <sub>STG</sub>	-55 to +150	°C

Notes

<sup>(1)</sup> Mounted on 10 mm x 10 mm PCB pad area

<sup>(2)</sup> Free air, mounted on recommended copper pad area

<sup>(3)</sup> The heat generated must be less than the thermal conductivity from junction-to-ambient:  $dP_D/dT_J < 1/R_{0JA}$ 







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<b>ELECTRICAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise noted)						
PARAMETER	TEST CO	TEST CONDITIONS		TYP.	MAX.	UNIT
Instantaneous forward voltage	I <sub>F</sub> = 1.5 A	$\frac{I_{F} = 1.5 \text{ A}}{I_{F} = 3 \text{ A}} T_{A} = 25 \text{ °C}$	V <sub>F</sub> <sup>(1)</sup>	0.45	-	V
	$I_F = 3 A$			0.51	0.59	
	I <sub>F</sub> = 1.5 A	– T <sub>A</sub> = 125 °C		0.35	-	
	I <sub>F</sub> = 3 A			0.44	0.52	
Reverse current	V - 60 V	= 60 V $T_A = 25 °C$ $T_A = 125 °C$	I <sub>R</sub> <sup>(2)</sup>	-	0.9	mA
	$v_{\rm R} = 00 v$			4.0	20.0	
Typical junction capacitance	4.0 V, 1 MF	4.0 V, 1 MHz		450	-	pF

#### Notes

 $^{(1)}\,$  Pulse test: 300  $\mu s$  pulse width, 1 % duty cycle

<sup>(2)</sup> Pulse test: pulse width  $\leq$  5 ms

<b>THERMAL CHARACTERISTICS</b> ( $T_A = 25 \text{ °C}$ unless otherwise specified)				
PARAMETER	SYMBOL	V3P6L	UNIT	
Typical thermal resistance	R <sub>0JA</sub> <sup>(1)</sup>	125	°C/W	
	R <sub>0JM</sub> <sup>(2)</sup>	15		

#### Notes

 $^{(1)}$  Free air, mounted on recommended PCB, 1 oz. pad area; thermal resistance  $R_{\theta JA}$  - junction-to-ambient

<sup>(2)</sup> Mounted on 10 mm x 10 mm copper pad area PCB; thermal resistance  $R_{\theta JM}$  - junction-to-mount

ORDERING INFORMATION (Example)						
PREFERRED P/N	UNIT WEIGHT (g)	PREFERRED PACKAGE CODE	BASE QUANTITY	DELIVERY MODE		
V3P6L-M3/H	0.024	Н	3000	7" diameter plastic tape and reel		
V3P6L-M3/I	0.024	l	10 000	13" diameter plastic tape and reel		
V3P6LHM3/H <sup>(1)</sup>	0.024	Н	3000	7" diameter plastic tape and reel		
V3P6LHM3/I (1)	0.024	I	10 000	13" diameter plastic tape and reel		

Note

(1) AEC-Q101 qualified



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## **RATINGS AND CHARACTERISTICS CURVES** ( $T_A = 25 \text{ °C}$ unless otherwise noted)

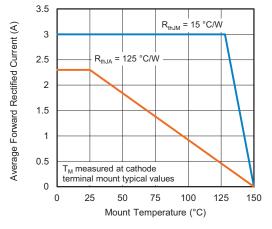


Fig. 1 - Maximum Forward Current Derating Curve

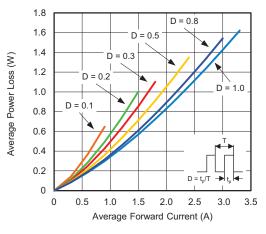


Fig. 2 - Forward Power Loss Characteristics

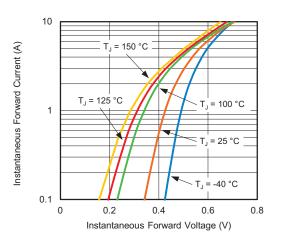


Fig. 3 - Typical Instantaneous Forward Characteristics

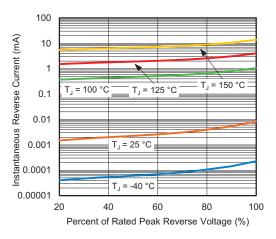


Fig. 4 - Typical Reverse Characteristics

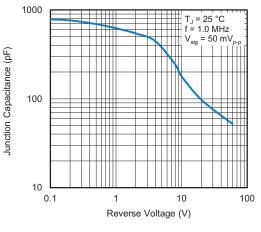


Fig. 5 - Typical Junction Capacitance

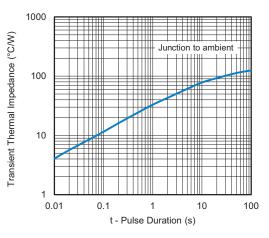


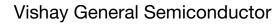
Fig. 6 - Typical Transient Thermal Impedance

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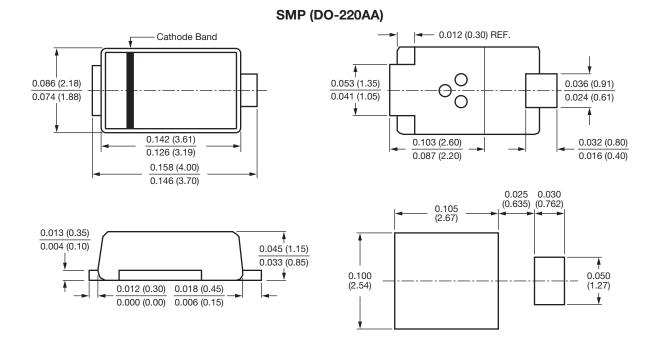
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## PACKAGE OUTLINE DIMENSIONS in inches (millimeters)





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